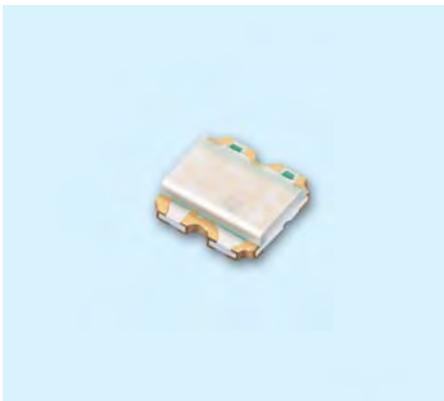


SMD ■ B EAST1616RGBC2



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Full-color type.
- Pb-free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

The EAST1616RGBC2 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained. Besides, lightweight makes them ideal for miniature applications.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Code	Chip Materials	Emitted Color	Resin Color
RS	AlInGaN	Brilliant Red	
BH	InGaN	Blue	Water Clear
GH	InGaN	Brilliant Green	

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Code	Rating	Unit
Reverse Voltage	V_R		5	V
Forward Current	I_F		25	mA
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	RS	60	mA
		BH	100	
		GH	100	
Power Dissipation	P_d	RS	60	mW
		BH	80	
		GH	80	
Electrostatic Discharge(HBM)	ESD	RS	2000	V
		BH	150	
		GH	150	
Operating Temperature	T_{opr}		-40 ~ +85	°C
Storage Temperature	T_{stg}		-40 ~ +90	°C
Soldering Temperature	T_{sol}		Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Code	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I _v	RS	450	-----	715	mcd	
		BH	180	-----	360		
		GH	900	-----	1800		
Viewing Angle	2θ _{1/2}		-----	120	-----	Deg	
Peak Wavelength	λ _p	RS	-----	632	-----	nm	
		BH	-----	468	-----		
		GH	-----	518	-----		
Dominant Wavelength	λ _d	RS	620	-----	630	nm	I _F =20mA
		BH	465	-----	475		
		GH	525	-----	535		
Spectrum Radiation Bandwidth	Δλ	RS	-----	20	-----	nm	
		BH	-----	25	-----		
		GH	-----	35	-----		
Forward Voltage	V _F	RS	1.7	-----	2.4	V	
		BH	2.6	-----	3.2		
		GH	2.6	-----	3.2		
Reverse Current	I _R	RS	-----	-----	10	μA	V _R =5V
		BH	-----	-----	50		
		GH	-----	-----	50		

Note:

1. Tolerance of Luminous Intensity: ±11%
2. Tolerance of Dominant Wavelength: ±1nm
3. Tolerance of Forward Voltage: ±0.1V
4. RA test @ 5mA

RS

Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
U1	450	565	mcd	I _F =20mA
U2	565	715		

BH

Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
S1	180	225	mcd	I _F =20mA
S2	225	285		
T1	285	360		

GH

Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
V2	900	1120	mcd	I _F =20mA
W1	1120	1420		
W2	1420	1800		

Bin Range Of Dom. Wavelength

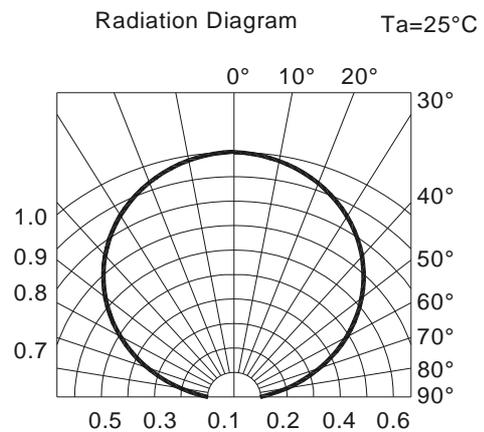
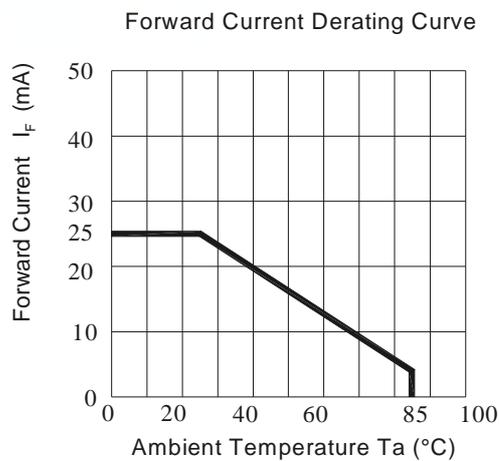
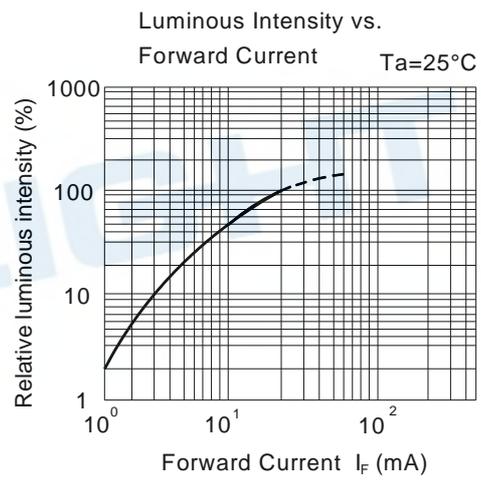
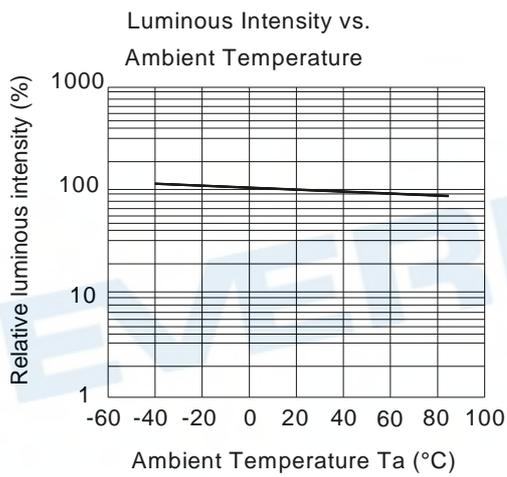
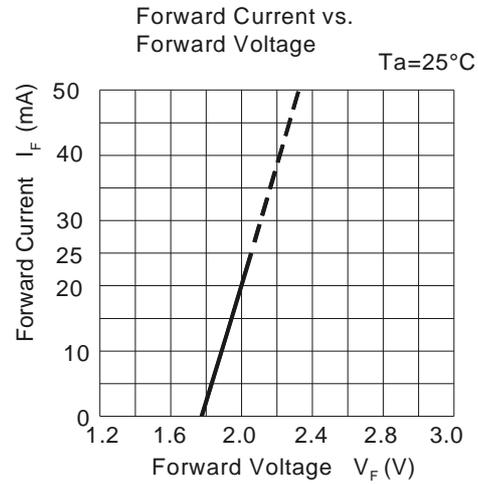
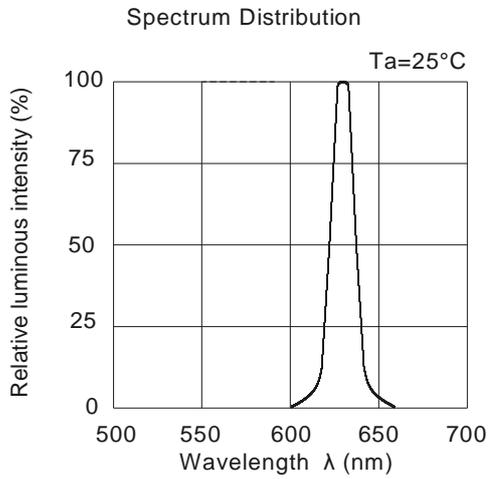
Bin Code	Min.	Max.	Unit	Condition
Y	525	530	nm	I _F =20mA
Z	530	535		

Note:

1. Tolerance of Luminous Intensity: $\pm 11\%$
2. Tolerance of Dominant Wavelength: $\pm 1\text{nm}$

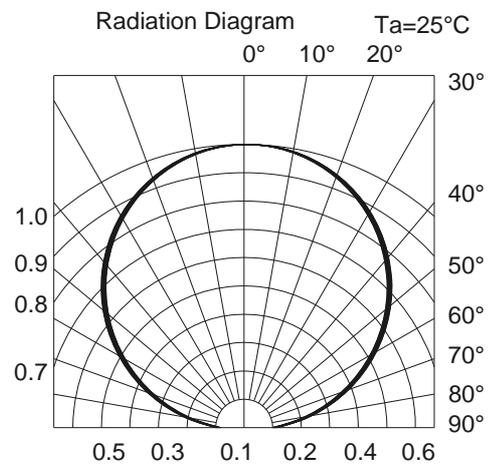
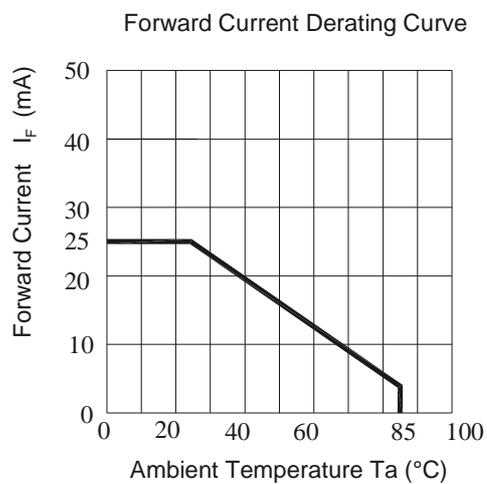
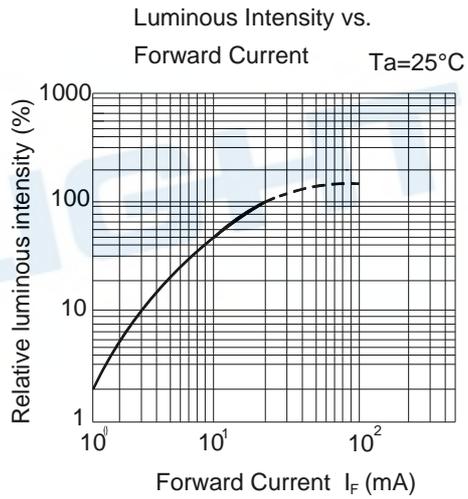
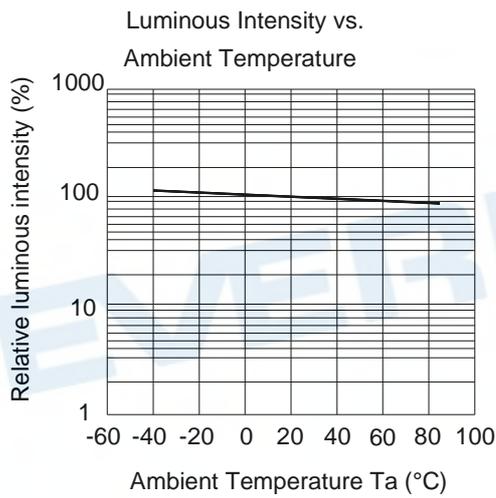
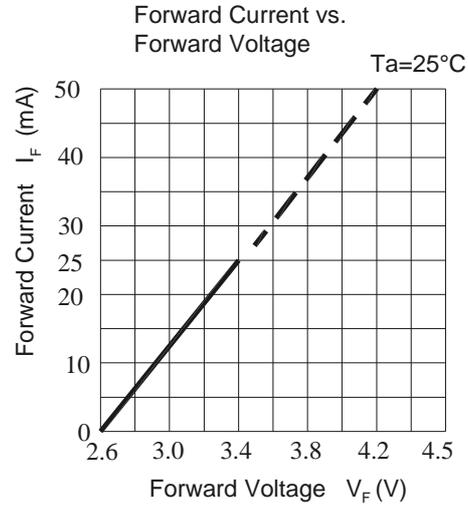
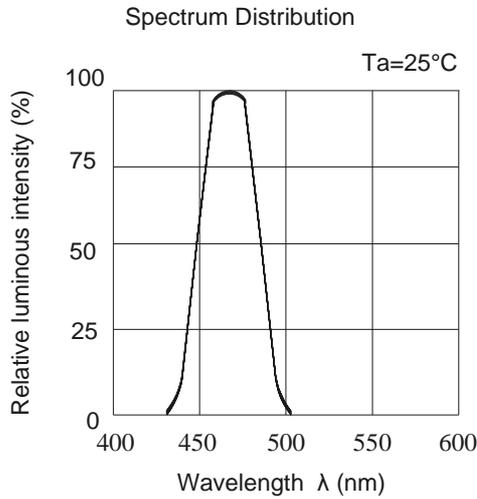
Typical Electro-Optical Characteristics Curves

RS



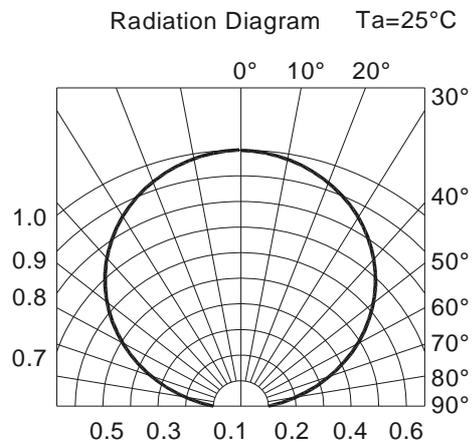
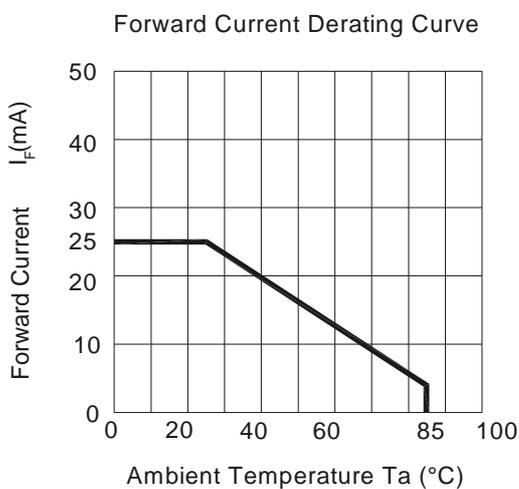
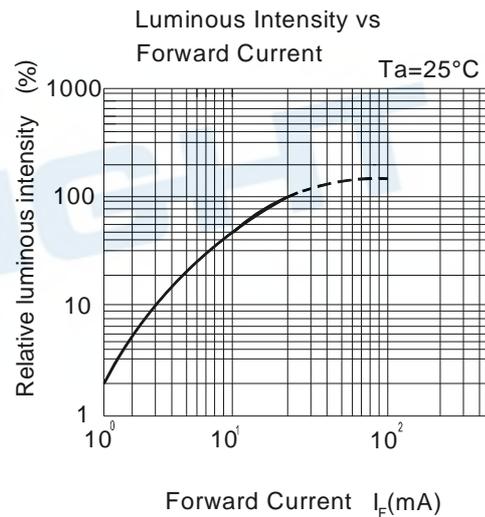
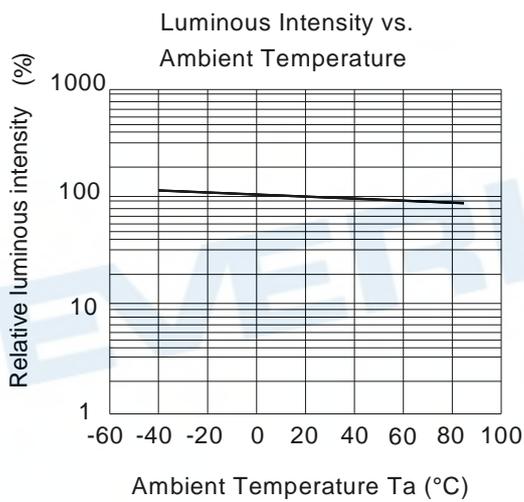
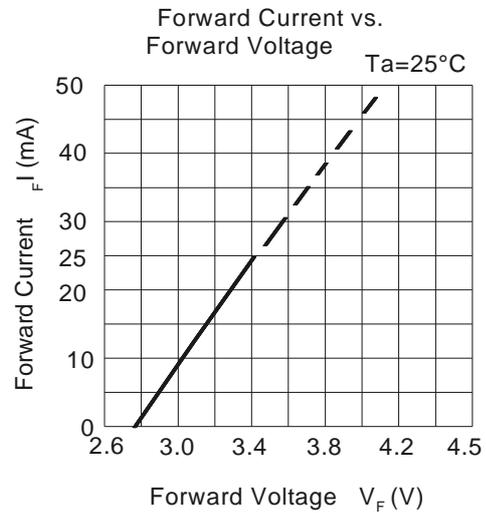
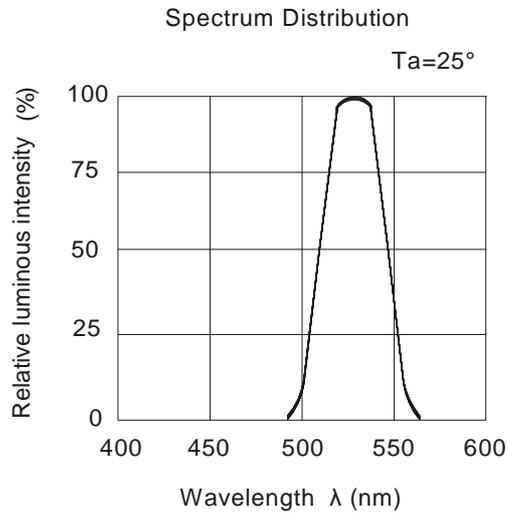
Typical Electro-Optical Characteristics Curves

BH

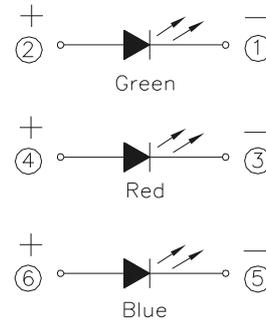
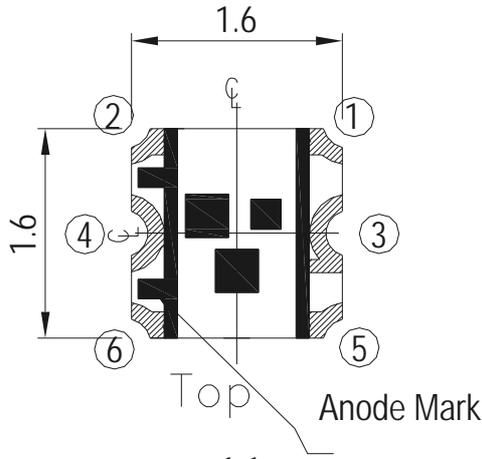


Typical Electro-Optical Characteristics Curves

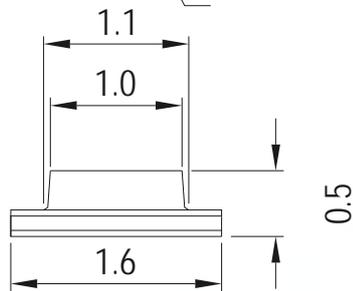
GH



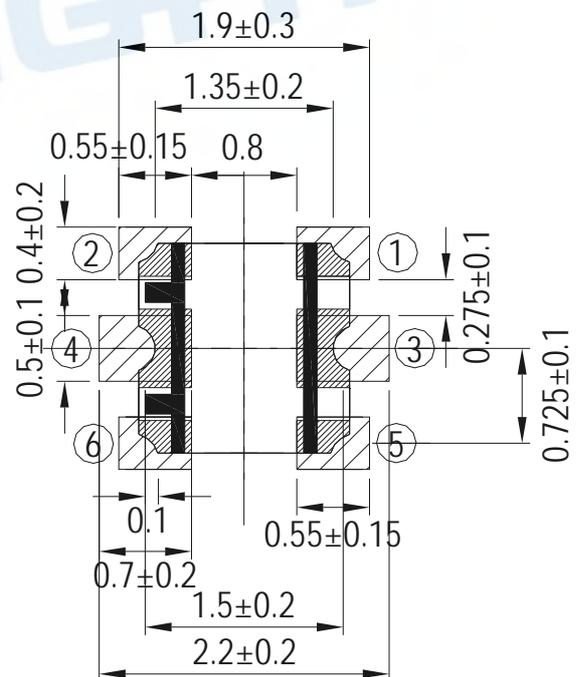
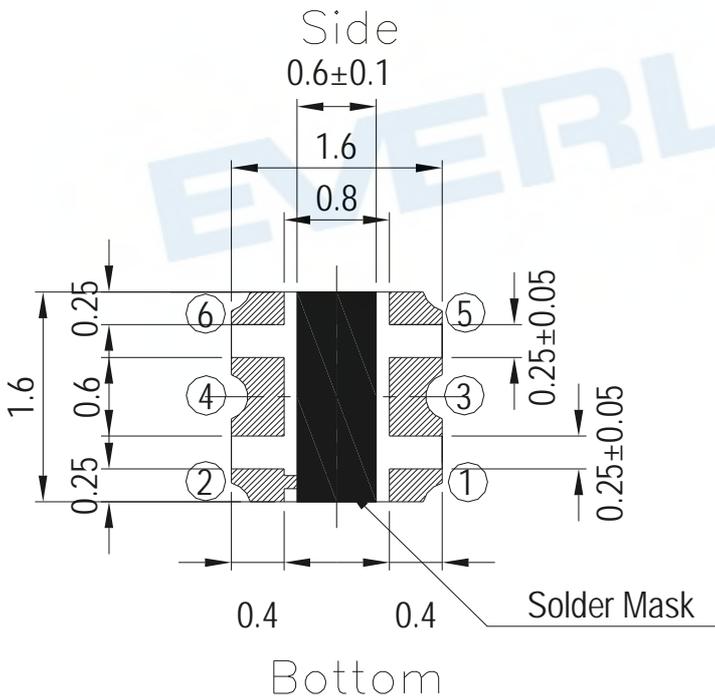
Package Dimension



Polarity



Recommend soldering pad



Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm

Moisture Resistant Packing Materials

Label Explanation



5

- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

CPN: XXXXXXXXXXXXXXXXXXXXXXXX 測試區

XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX

P/N: XXXXXXXXXXXXX

XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX

LOT NO: Y150716XXX-XXXXXXXXXX-XXXXXXXXXX

XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX

QTY: 0123456789 HUE: XXXXXXXXXXXXX

CAT: XXXXXXXXXXXXX REF: XXXXXXXXXXXXX

XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX

REFERENCE: BTPYMMDDXXXXXX

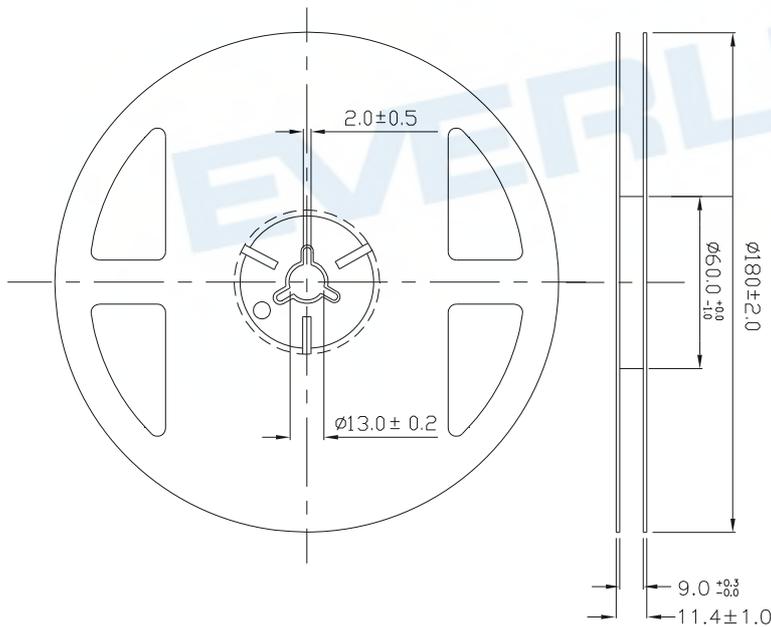
XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX

MSL-2a

MADE IN TAIWAN



Reel Dimensions

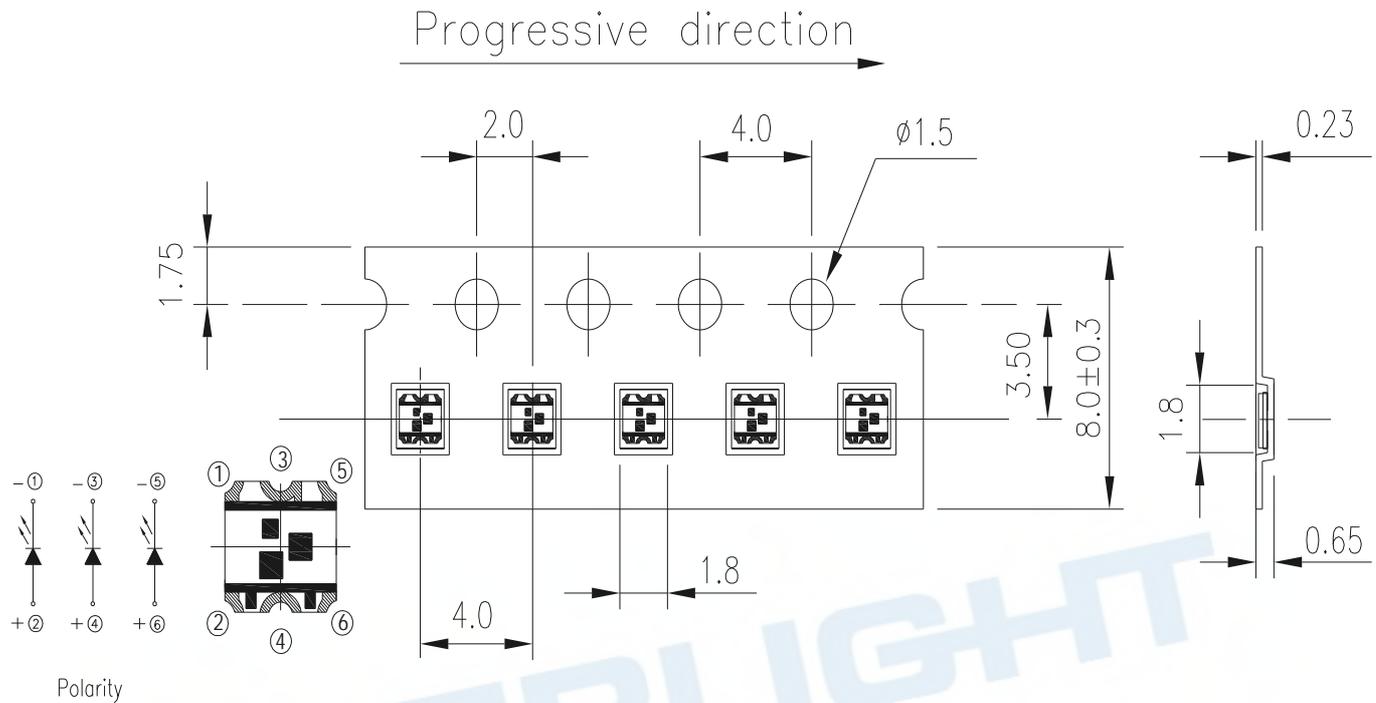


Note: The tolerances unless mentioned is ±0.1mm ,Unit = mm

Carrier Tape Dimensions: Loaded quantity 4000 PCS per reel

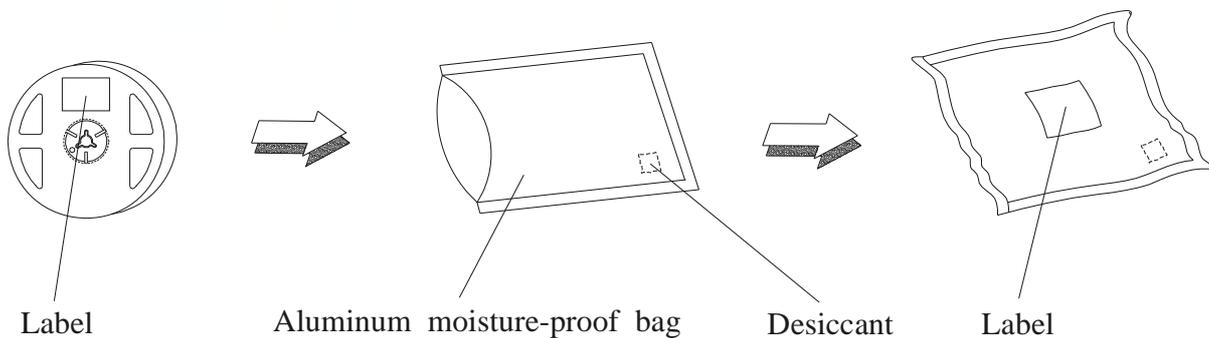
The minimum quantity of packing is 4000 pcs per reel.

The rest quantity which could not reach 4000 pcs per reel will go to 2000 pcs per reel.



Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit = mm

Moisture Resistant Packaging



Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less.

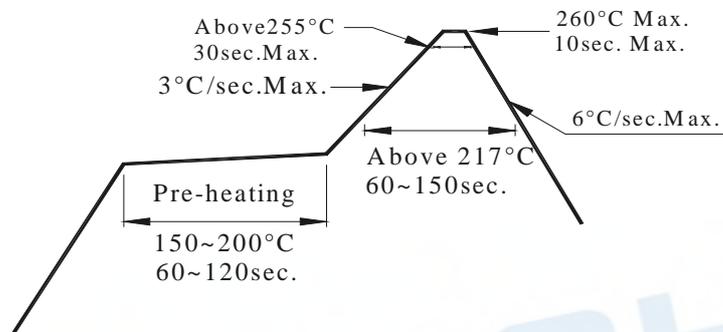
If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

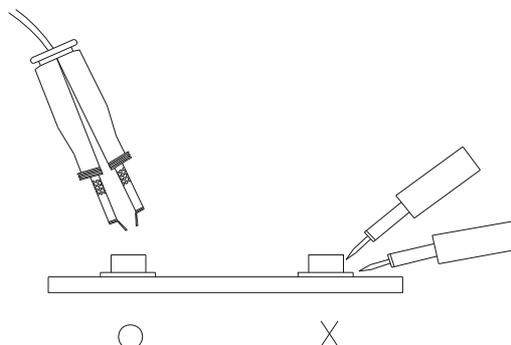
3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

DISCLAIMER

1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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